

Part Number: XZCFBB74W-3VU

2.1 x 0.6 mm Ultra Low Current Series

Features

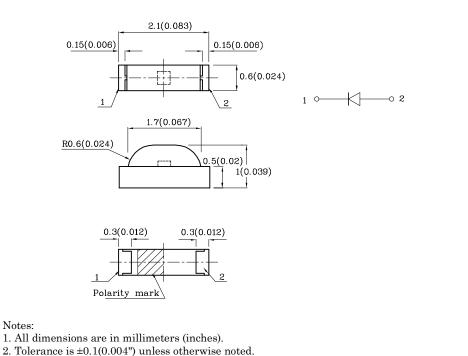
- Ideal for indication light on hand held products
- Long life and robust package
- Standard Package: 2,000pcs/ Reel
- MSL (Moisture Sensitivity Level): 3
- Halogen-free
- RoHS compliant





ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

Package Schematics



3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T _A =25°C)	Blue (InGaN)	Unit		
Reverse Voltage	V_{R}	5	V	
Forward Current	$\mathbf{I}_{\mathbf{F}}$	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	$i_{\rm FS}$	100	mA	
Power Dissipation	\mathbf{P}_{D}	120	mW	
Operating Temperature	TA	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +85		
Electrostatic Discharge Threshold (HBM)	250	V		

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Operating Characteristics (T _A =25°C)		Blue (InGaN)	Unit
Forward Voltage (Typ.) (I _F =2mA)	V_{F}	2.65	V
Forward Voltage (Max.) (I _F =2mA)	V_{F}	3.0	V
Reverse Current (Max.) (V _R =5V)	I_R	50	μΑ
Wavelength of Peak Emission CIE127-2007* (Typ.) (I _F =2mA)	λP	465*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I _F =2mA)	λD	470*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =2mA)	$ riangle \lambda$	22	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	100	$_{\rm pF}$

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous CIE127- (I _F =2 m	2007* 2mA)	Wavelength CIE127-2007* nm λP	Viewing Angle 20 1/2
				min.	typ.		
XZCFBB74W-3VU	Blue	InGaN	Water Clear	10*	19*	465*	170°

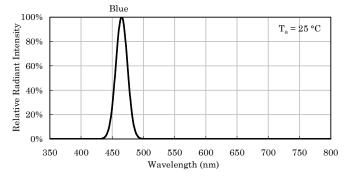
*Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

Dec 02,2020

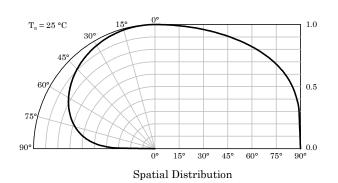
XDSB9213 V3-Z Layout: Maggie L.



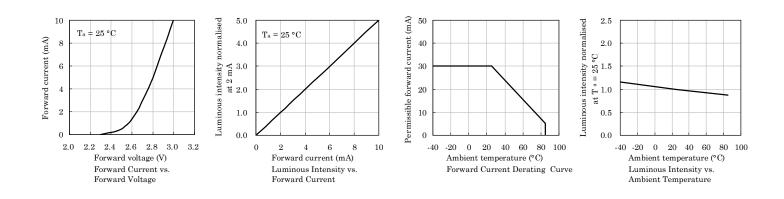
2.1 x 0.6 mm Ultra Low Current Series



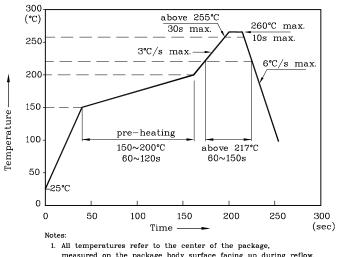
Relative Intensity Vs. CIE Wavelength







LED is recommended for reflow soldering and soldering profile is shown below.



Reflow Soldering Profile for SMD Products (Pb-Free Components)

measured on the package body surface facing up during reflow. 2. Do not apply any stress to the LED during high temperature conditions.

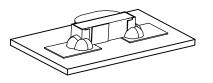
3. Maximum number of soldering passes: 2

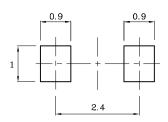


 $2.1 \ge 0.6$ mm Ultra Low Current Series

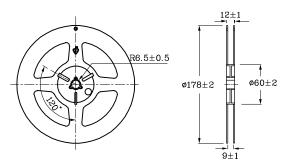
✤ The device has a single mounting surface. The device must be mounted according to the specifications.

Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)

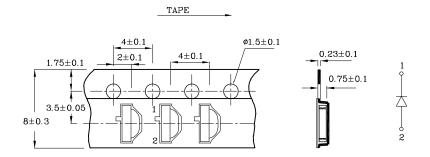




Reel Dimension (Units : mm)



Tape Specification (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

2. Luminous intensity / luminous flux: +/-15%

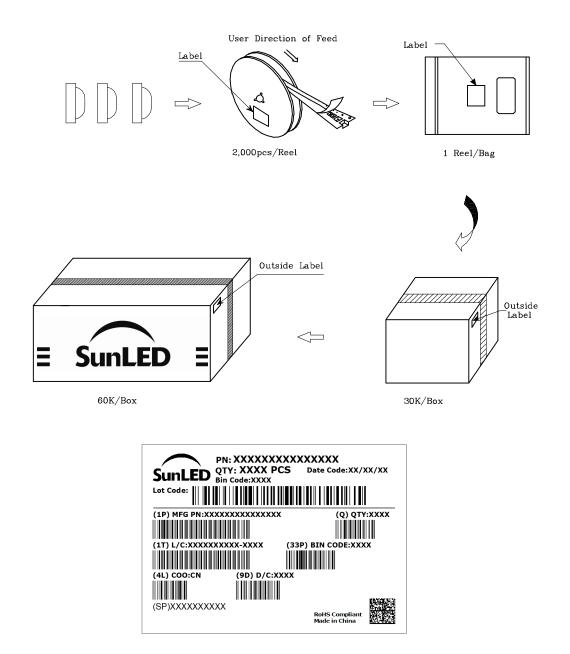
3. Forward Voltage: +/-0.1V $\,$

Note: Accuracy may depend on the sorting parameters.

Dec 02,2020



PACKING & LABEL SPECIFICATIONS



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- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet.
- User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please
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- $6. \ Additional \ technical \ notes \ are \ available \ at \ \underline{https://www.SunLEDusa.com/TechnicalNotes.asp}$